

Date: - 24 Jun, 2004

Data Sheet Issue:

Provisional Data

Rectifier Diode

Types W5292T#500 to W5292

Development Type No.: WX043TC500-560

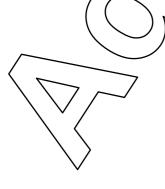
Absolute Maximum Ratings

	VOLTAGE RATINGS		MAXIMUM LIMITS	UNITS
V_{RRM}	Repetitive peak reverse voltage, (note 1)	/	5000-5600	V
V_{RSM}	Non-repetitive peak reverse voltage, (note 1)	\sim	5100-5700	V

	OTHER RATINGS	MAXIMUM LIMITS	UNITS
I _{F(AV)M}	Maximum average forward current, T _{sink} =55°C, (note 2)	5292	Α
$I_{F(AV)M}$	Maximum average forward current. T _{sink} =100°C (note 2)	3680	Α
I _{F(AV)M}	Maximum average forward current. T _{sink} 100°C, (note 3)	2271	Α
I _{F(RMS)M}	Nominal RMS forward current, T _{sink} =25°C, (note 2)	9724	Α
I _{F(d.c.)}	D.C. forward current, T _{sink} =25°C, (note 4)	8543	Α
I _{FSM}	Peak non-repetitive surge t _p =10 ms V _m =60% V _{RRM} , (note 5)	52.7	kA
I _{FSM2}	Peak non-repetitive surge t _p =10ms, V _{rm} ≤10V, (note 5)	58.0	kA
l ² t	I ² t capacity for fusing t _p =10ms, V _m =60%V _{RRM} , (note 5)	13.9×10 ⁶	A ² s
l ² t	I^2 t capacity for fusing $t_p \neq 10$ ms, $v_{eq} \leq 10$ V (note 5)	16.8×10 ⁶	A ² s
T _{j op}	Operating temperature range	-40 to +160	°C
T _{stg}	Storage temperature lange ()	-55 to +160	°C

- De-rating factor of 0.13% per C is applicable for T_j below 25°C.
 Double side cooled, single phase; 50Hz, 180° half-sinewave.
 Single side cooled, single phase; 50Hz, 180° half-sinewave.
 Double side cooled.

- 5) Half-sinewave 160°6 T_i initial.





Characteristics

i 						
	PARAMETER	MIN.	TYP.	MAX.	TEST CONDITIONS (Note 1)	UNITS
V_{FM}	Maximum peak forward voltage	-	-	1.70	I _{TM} =6000A	V
V_{FM}	Maximum peak forward voltage	-	-	2.79	I _{TM} =15900A	V
V_{T0}	Threshold voltage	-	-	1.027		V
r _T	Slope resistance	-	-	0.111		mΩ
I _{RRM}	Peak reverse current	-	-	200	Rated V _{RR} M	mA
I _{RRM}	Peak reverse current	-	-	30	Rated V _{RRM} , V _j =25/C	mA
Q _{rr}	Recovered charge	-	18000	- /		μC
Q _{ra}	Recovered charge, 50% Chord	-	12000	14000	T _M =4000A, t _p =2000μs, di/dt=10A/μs,	μC
Irr	Reverse recovery current	-	360	/- <	V _r =100V	Α
trr	Reverse recovery time	-	68			μs
D	Thermal registance junction to be steinly	-	-	0.008	Double side cooled	K/W
R_{thJK}	Thermal resistance, junction to heatsink	-	-	0.016	Single side cooled	K/W
F	Mounting force	63	- ,	777_		kN
\A/	Weight	-	1.28	\sim \sim	Outline Options TC and TT	les.
Wt	Weight	_	1.70	// /	Outline Options TD and TV	kg

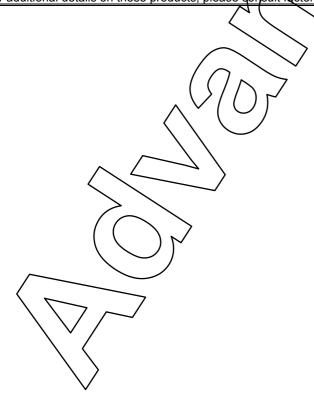
Notes:-

- 1) Unless otherwise indicated T_i=160°C.
- 2) For other clamp forces, please consult factory.

Notes on rupture rated packages.

This product is available with a non-rupture rated package.

For additional details on these products, please done will factory.



Notes on Ratings and Characteristics

1.0 Voltage Grade Table

Voltage Grade	V _{RRM} V	V_{RSM} V	DC P
50	5000	5100	2200
52	5200	5300	2240
54	5400	5500	2280
56	5600	5700	2320

2.0 Extension of Voltage Grades

This report is applicable to other voltage grades when supply has been agreed by Sales/Production.

3.0 De-rating Factor

A blocking voltage de-rating factor of 0.13%/°C is applicable to this device for Tibelow 25°C.

4.0 Snubber Components

When selecting snubber components, care must be taken not to use excessively large values of snubber capacitor or excessively small values of snubber resistor. Such excessive component values may lead to device damage due to the large resultant values of snubber discharge current. If required, please consult the factory for assistance.

5.0 Computer Modelling Parameters

5.1 Device Dissipation Calculations

$$I_{AV} = \frac{-V_{T0} + \sqrt{{V_{T0}}^2 + 4 \cdot ff^2 \cdot r_r \cdot W_{AV}}}{2 \cdot ff^2 \cdot r_T} \qquad \text{and:}$$

$$W_{AV} = \frac{\Delta T}{R_{th}}$$

$$\Delta T = T_{j \max} - T_{K}$$

Where V_{T0} =1.027V, r_{T} =0.111m Ω ,

 $R_{\it th}$ = Supplementary thermal impedance, see table below and

ff = Form factor, see table below.

Supplementary Thermal Impedance					
Conduction Angle	6 phase (60°)	3 phase (120°)	½ wave (180°)	d.c.	
Square wave Double Side Cooled	0.00907	0.00891	0.00878	0.008	
Square wave Single Side Gooled	0.01781	0.01759	0.01731	0.016	
Sine wave Double Side Cooled	0.00903	0.00884	0.00867		
Sine wave Single Side Cooled	0.01775	0.01735	0.01682		

	Form Factors				
Conduction Angle	6 phase (60°)	3 phase (120°)	½ wave (180°)	d.c.	
Square-wave	2.449	1.732	1.414	1	
Sine wave	2.778	1.879	1.57		



5.2 Calculating V_F using ABCD Coefficients

The on-state characteristic I_F vs. V_F, on page 6 is represented in two ways;

- (i) the well established V_{T0} and r_T tangent used for rating purposes and
- (ii) a set of constants A, B, C, D, forming the coefficients of the representative equation for V_F in terms of I_F given below:

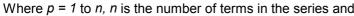
$$V_F = A + B \cdot \ln(I_F) + C \cdot I_F + D \cdot \sqrt{J_F}$$

The constants, derived by curve fitting software, are given below for both hot and colo characteristics. The resulting values for V_F agree with the true device characteristic over a curvent range, which is limited to that plotted.

25°C Coefficients A 0.61079656 0.615582755 B 0.0234119 -0.02994657 C 6.6199×10 ⁻⁵ 6.917×10 ⁻⁵ D 3.72241×10 ⁻³ 0.01174699			
B 0.0234119 -0.02994657 C 6.6199×10 ⁻⁵ 6.917×10 ⁻⁵		25°C Coefficients	160 C Coefficients
C 6.6199×10 ⁻⁵ 6.917×10 ⁻⁵	Α	0.61079656	0.615582758
<u> </u>	В	0.0234119	-0.02994657
D 3.72241×10 ⁻³ 9.01174699	С	6.6199×10 ⁻⁵	6.917×10 ⁻⁵
	D	3.72241×10 ⁻³	9.01174699

5.3 D.C. Thermal Impedance Calculation

$$r_t = \sum_{p=1}^{p=n} r_p \cdot \left(1 - e^{\frac{-t}{\tau_p}}\right)$$



t = Duration of heating pulse in seconds.

 r_{\star} = Thermal resistance at time t.

 r_p = Amplitude of p_{th} term.

 τ_p = Time Constant of r_{th} term.

The coefficients for this device are shown in the tables below:

auon	
$r_{p} = \sum_{p=1}^{p=n} r_{p} \cdot \left(1 - e^{\frac{-t}{\tau_{p}}}\right)$	
ns in the series and:	

		D.C. Single Side	Cooled	
Term	1	2	3	4
r_p	0.01551	2.7827×10 ⁻³	4.2105×10 ⁻³	9.443×10 ⁻⁴
$ au_{ ho}$	10.04275	1.783567	0.2231307	3.428×10 ⁻³

		D.C. D	ouble Side Cooled		
Term	1	2	(30)	4	5
r_p	6.4176×10 ⁻³	2.7472×10 ⁻³	1/2515×10 ⁻³	0.6336×10 ⁻³	0.59597×10 ⁻³
$ au_{ ho}$	1.785337	0.34595	0.0099651	0.014214	2.298151×10 ⁻³

6.0 Reverse recovery ratings

(i) Q_{ra} is based on 50% I_{rm} chord as shown in Fig.

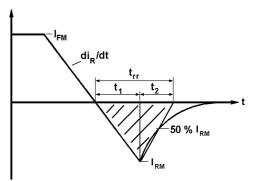
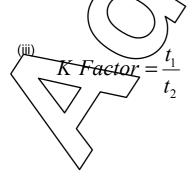
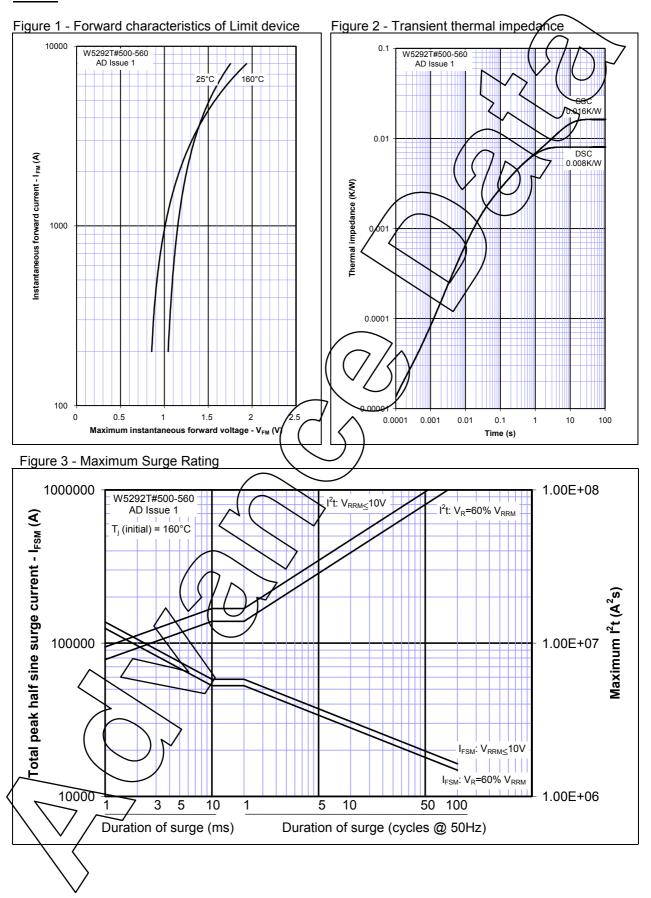


Fig. 1



$$Q_{rr} = \int_{0}^{150 \, \mu s} i_{rr}.dt$$

Curves



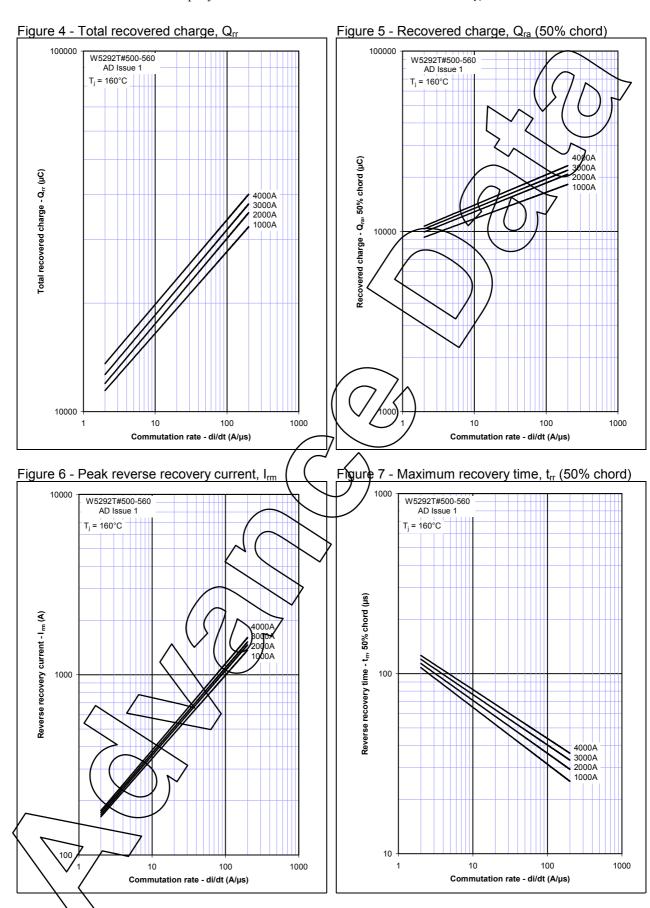


Figure 8 – Forward current vs. Power dissipation – Double Side Cooled

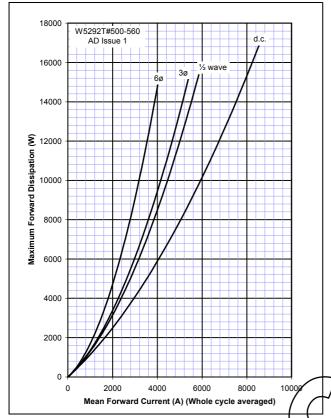


Figure 9 – Forward current vs. Heatsink temperature - Double Side Cooled

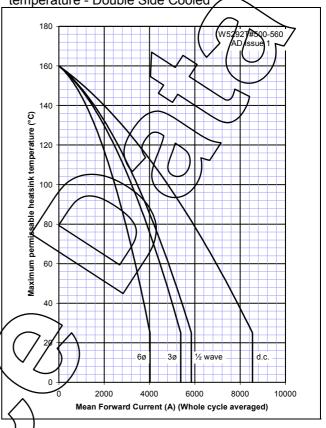


Figure 10 – Forward current vs. Power dissipation – Single Side Cooled

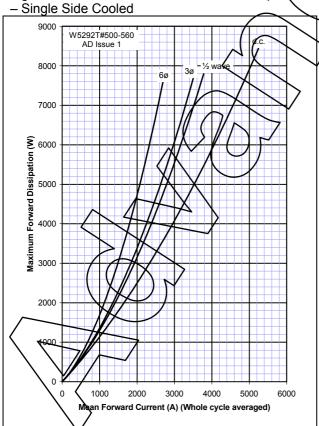
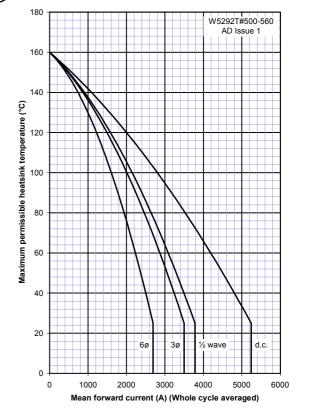
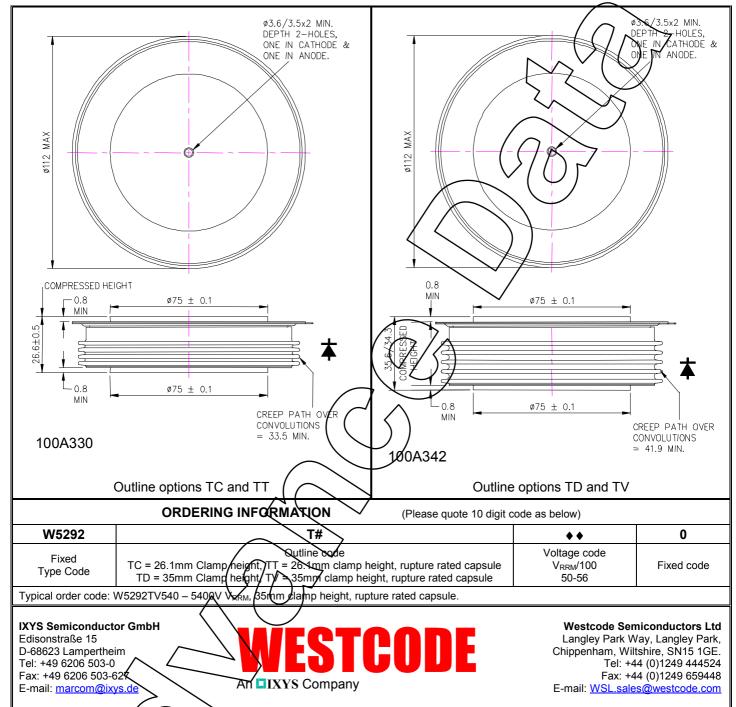


Figure 11 – Forward current vs. Heatsink temperature – Single Side Cooled





Outline Drawing & Ordering Information



IXYS Corporation 3540 Bassett Street

Santa Clara CA 95054 Tel: +1 (408) 982 0700 Fax: +1 (408) 496 0670

E-mail:

www.westcode.com

www.ixys.com

Westcode Semiconductors Inc

3270 Cherry Avenue Long Beach CA 90807 USA Tel: +1 (562) 595 6971 Fax: +1 (562) 595 8182

E-mail: WSI.sales@westcode.com

The informa dential and is protected by Copyright. The information may not be used or disclosed permission of and in the manner permitted by the proprietors Westcode Semiconductors Ltd. except with the

In the interest of p ovement. Westcode reserves the right to change specifications at any time without prior notice.

Devices with a suffix of e (2-letter, 3-letter or letter/digit/letter combination) added to their generic code are not necessarily subject to the conditions and lin ned in this report.

© Westcode Semiconductors Ltd.